



PRESS RELEASE

SMARTRAC's Durasoft® material has become a registered trade mark

- **Durasoft® a key element for SMARTRAC's leadership in ePassport programmes**
- **Strong and durable characteristics of Durasoft® allow future roll-out in a variety of secure inlay applications**

Amsterdam, 3 October 2006. SMARTRAC announced today that it has successfully registered „DURASOFT” as a trade mark in the U.S. Patent and Trademark Office on 14 September 2006. DURASOFT is a unique synthetic multilayer material for electronic Passport (ePassport) inlays and is developed by SMARTRAC. The strong and durable characteristics of this new material protect the electronic components of an ePassport but still maintain the feeling of a strong paper. Through its flexibility and durability DURASOFT can also bond to various other outer surfaces and this flexibility combined with the durability make it an ideal material for further high security applications. Over the last years DURASOFT was further developed and is today available in several different versions to meet any specific requirement in ePassport production.

“With the successful acceptance and roll-out of DURASOFT-based inlays in many countries that are launching ePassport projects, SMARTRAC has established itself as the number 1 secure inlay supplier in the world. In addition, SMARTRAC is the patent holder for wire embedding technology that is internationally accepted and the most proven inlay antenna manufacturing technology,” said Manfred Rietzler, CEO of SMARTRAC N.V.

SMARTRAC is certified supplier for more than 20 countries including the US ePassport program.

About SMARTRAC N.V.

SMARTRAC is a leading supplier of inlays for contactless credit cards (ePayment) and passports with integrated contactless chips (ePassports). The company, which was founded in 2000, is incorporated under Dutch law and has its head office in Amsterdam. SMARTRAC has its main production and R&D center in Bangkok (Thailand), as well as subsidiaries in Germany and Singapore. Through an agreement with Xytec Solutions (Kulim, Malaysia), in which SMARTRAC holds a 30% stake, the company has exclusive access to proprietary manufacturing equipment. In two product segments - Standard and High Security - SMARTRAC manufactures components for RFID applications in public transport, access control and logistics, as well as in the high-security applications of ePayment and ePassport.



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